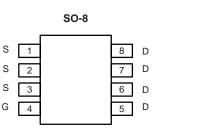
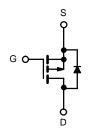


## P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
	0.015 at V <sub>GS</sub> = - 4.5 V	- 13 <sup>a</sup>			
- 20	0.021 at V <sub>GS</sub> = - 2.5 V	- 10 <sup>a</sup>	20 nC		
	0.040 at V <sub>GS</sub> = - 1.8 V	- 8			



Top View



P-Channel MOSFET

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested Built in ESD Protection with Zener Diode
- Typical ESD Performance: 1800 V
- Compliant to RoHS Directive 2002/95/EC

#### COMPLIANT HALOGEN **FREE**

#### **APPLICATIONS**

- Portable Devices
  - Load Switch
  - Battery Switch
  - Charger Switch

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25  ^{\circ}C$ , unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage		V <sub>DS</sub>	- 20	V		
Gate-Source Voltage	$V_{GS}$	± 12	V			
	T <sub>C</sub> = 25 °C		- 13 <sup>a</sup>			
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I_	- 10 <sup>a</sup>			
Continuous Diam Current (1) = 130 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 8 <sup>b, c</sup>	А		
	T <sub>A</sub> = 70 °C		- 7.1 <sup>b, c</sup>			
Pulsed Drain Current	I <sub>DM</sub>	- 50				
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	- 6 <sup>a</sup>			
Continuous Godree Brain Blode Carrent	T <sub>A</sub> = 25 °C	S	- 2.9 <sup>b, c</sup>	ı		
	$T_C = 25 ^{\circ}C$		19	W		
Maximum Power Dissipation	$T_C = 70  ^{\circ}C$	P <sub>D</sub>	12			
Waximum Fower Dissipation	T <sub>A</sub> = 25 °C	' D	3.5 <sup>b, c</sup>	VV		
	T <sub>A</sub> = 70 °C		2.2 <sup>b, c</sup>			
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C			
Soldering Recommendations (Peak Temperature		260	0			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, e</sup>	t ≤ 5 s	R <sub>thJA</sub>	28	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	5.3	6.5	O/ VV	

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- e. Maximum under Steady State conditions is 80 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 12		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = - 250 μA		3			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 0.5		- 1.2	V	
Cata Causas I agliana	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 20		
Gate-Source Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 0.5		
Zoro Coto Voltago Proin Current	,	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5.6 A		0.015			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, I_D = -5.3 \text{ A}$		0.021		Ω	
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 2.5 A		0.040			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 5.6 A		35		S	
Dynamic <sup>b</sup>							
Total Gate Charge	narge V <sub>DS</sub> = -1			50	75		
	$Q_g$	30 30 2		20	30	nC	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5 \text{ A}$		3.3			
Gate-Drain Charge	$Q_{gd}$			8.4			
Gate Resistance	$R_g$	f = 1 MHz	0.2	1	2	kΩ	
Turn-On Delay Time	t <sub>d(on)</sub>			0.71	1.1		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 1 $\Omega$		1.7	2.6		
Turn-Off Delay Time		$I_D \cong$ - 5 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1		6	9		
Fall Time	t <sub>f</sub>	Ω		3.2	5		
Turn-On Delay Time	t <sub>d(on)</sub>			0.3	0.45	us	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 1 $\Omega$		0.6	0.9		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 5 A, $V_{GEN} =$ - 10 V, $R_g = 1$		10	15		
Fall Time	t <sub>f</sub>	Ω		3.5	5.5	1	
<b>Drain-Source Body Diode Characterist</b>	ics			•			
Continuous Source-Drain Diode Current	I <sub>S</sub>	$T_C = 25  ^{\circ}C$			- 6	Α	
Pulse Diode Forward Current	I <sub>SM</sub>				- 50	A	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 5 A, V <sub>GS</sub> = 0 V		- 0.85	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			30	60	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I _ 6 A dl/dt _ 100 A/::2 T _ 25 °C		20	40	nC	
Reverse Recovery Fall Time	ta	$I_F = 6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		13		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			17			

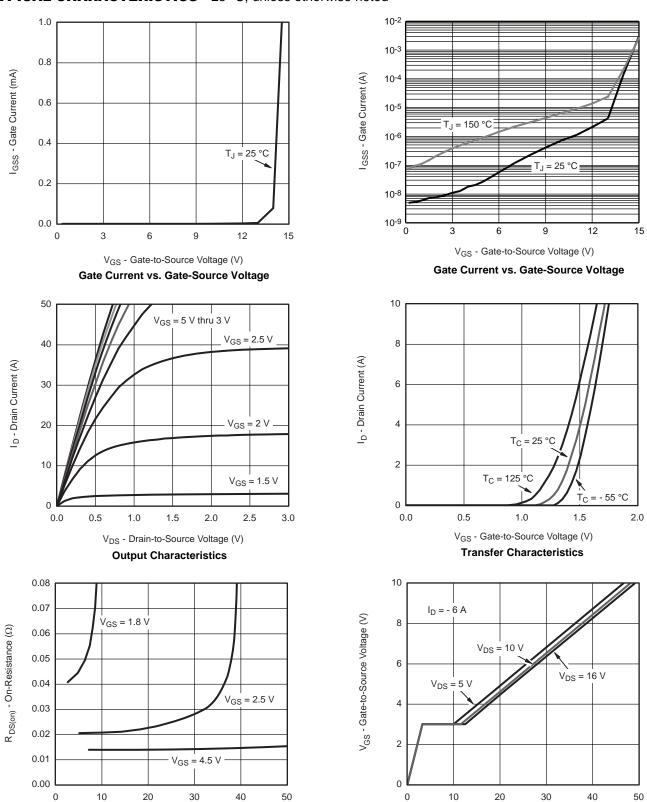
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$  b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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I<sub>D</sub> - Drain Current (A)

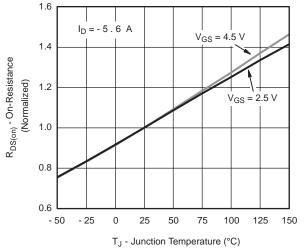
On-Resistance vs. Drain Current

Q<sub>q</sub> - Total Gate Charge (nC)

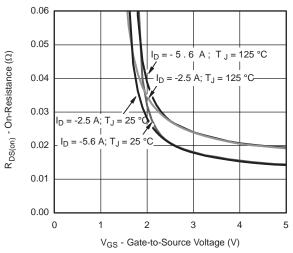
**Gate Charge** 



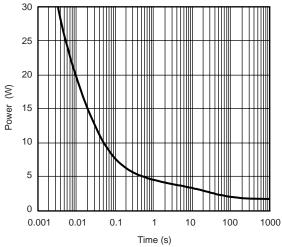
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



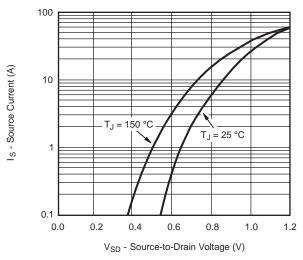
#### On-Resistance vs. Junction Temperature



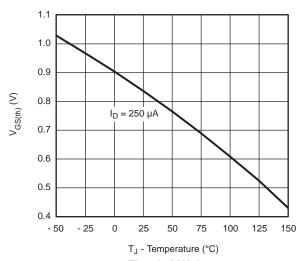
#### On-Resistance vs. Gate-to-Source Voltage



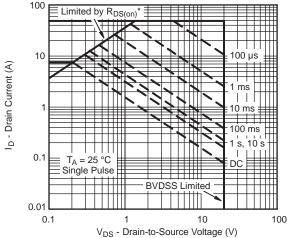
Single Pulse Power, Junction-to-Ambient



#### Soure-Drain Diode Forward Voltage



#### Threshold Voltage

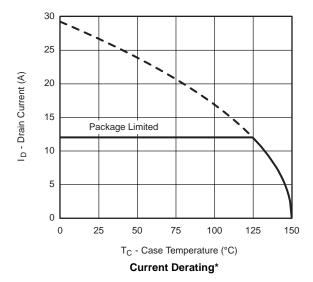


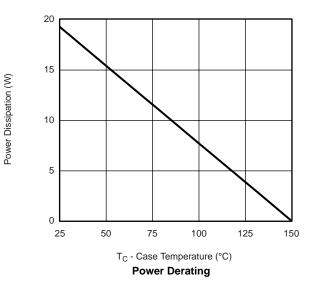
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





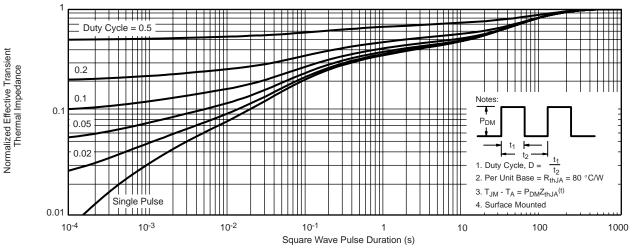
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<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

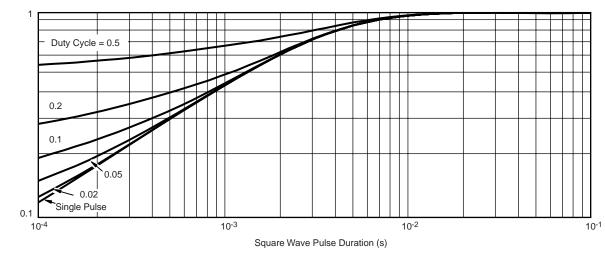
Normalized Effective Transient Thermal Impedance



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



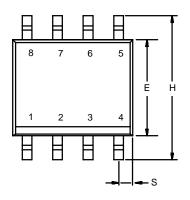
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case



**SOIC (NARROW): 8-LEAD** JEDEC Part Number: MS-012







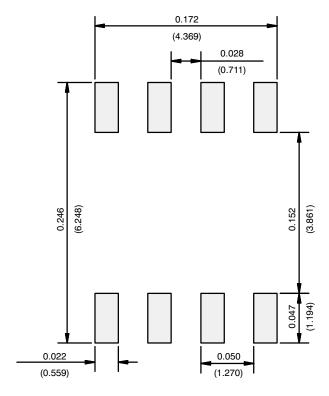
	MILLIMETERS		INCHES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
FCN: C-06527-Rev I 11-Sen-06					

ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498

服务热线:400-655-8788



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP NTMC083NP10M5L BXP7N65D BXP4N65F AOL1454G
WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13
SLF10N65ABV2 BSO203SP BSO211P IPA60R230P6